





# **Description**

The lead free resistors are constructed in a high grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and connected by a lead free resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

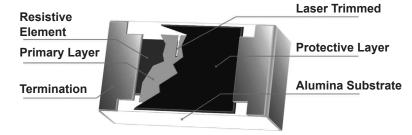
#### **Features**

- · Small size and light weight
- · High reliability and stability
- · Reduced size of final equipment
- · Higher component and equipment reliability
- · Higher component and equipment reliability

# **Applications**

- · Mobile phone
- PDA
- Camcorders
- · Palmtop computers
- · Hybrid module

## Construction



## **Quick Reference Data**

Item	General Specification		
Series No.	MCWR02X		
Size code	Size code 0201(0603)		
Resistance Range	$1\Omega \sim 10$ MΩ (±5% tolerance), Jumpe $1\Omega \sim 1$ MΩ (±1% tolerance)		
Resistance Tolerance	±1% E96/E24	±5% E24	
TCR (ppm/°C)	100Ω - 10MΩ, ±200 10Ω - 97.6Ω, +600 ~ 0 1 - 9.76Ω, +800~ -100		
Max. Dissipation @ Tamb = 70°C	1/20 W		
Max. Operation Voltage (DC or RMS)	25V		
Max. Overload Voltage (DC or RMS)	50V		
Climatic category (IEC 60068)	55/125/56		

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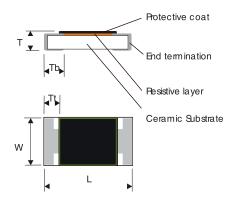




#### Note:

Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by RCWV = Rated Power × Resistance Value or Max. RCWV listed above, whichever is lower.

## **Dimension**



Туре	MCWR02X(W)			
L	0.6 ±0.03			
W	0.3 ±0.03			
Т	0.23 ±0.03			
Tb	0.15 ±0.05			
Tt	0.1 ±0.05			

Dimensions: Millimetres

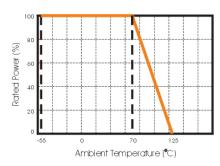
# **Functional Description:**

#### **Product characterization**

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of ±5% & ±1%.

#### Derating

The power that the resistor can dissipate depends on the operating temperature



Max. Dissipation in percentage of rated power as a function of the ambient temperature

#### Mounting

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

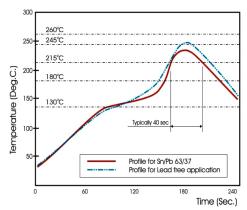
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## **Soldering Condition:**

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount surface mount resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given below.



Infrared soldering profile for Chip Resistors MCWR02X(W)

# **Test and Requirements:**

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

Test	Dunnadius / Took Makkad	Requirement	
	Procedure / Test Method	Resistor	0Ω
DC resistance	DC resistance values measured at the test voltages specified below : $<10\Omega$ @ $0.1V$ , $<100\Omega$ @ $0.3V$ , $<1k\Omega$ @ $1.0V$ , $<10k\Omega$ @ $3V$ , $<100k\Omega$ @ $10V$ , $<10M\Omega$ @ $25V$ , $<10MW$ @ $30V$	Within the specified tolerance	<50mΩ
Temperature coefficient of resistance (T.C.R)	Natural resistance change per change in degree centigrade. $\begin{array}{c} R_2 - R_1 \\ R_1 \ (t_2 - t_1) \end{array} \times 10^6 \ (ppm/^{\circ}C)  t_1 : 20^{\circ}C \ +5^{\circ}C - 1^{\circ}C \end{array}$	Refer to "Quick Reference Data"	NA
	R <sub>1</sub> : Resistance at reference temperature R <sub>2</sub> : Resistance at test temperature		



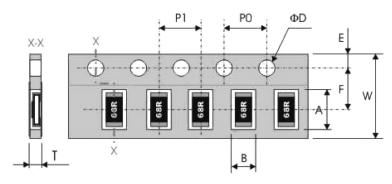




Tool	Dunnadawa / Tank Markhad	Requirement		
Test	Procedure / Test Method	Resistor	0Ω	
Short time overload (S.T.O.L)	Permanent resistance change after a 2 second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	$\Delta$ R/R max. ±(1%+0.05 $\Omega$ )	<50mΩ	
Resistance to soldering heat (R.S.H)	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C ±5°C	$\Delta$ R/R max. ±(1%+0.05 $\Omega$ ) no visible damage	<50mΩ	
Solderability	Un-mounted chips completely immersed for 2±0.8second in a SAC solder bath at 235°C ±5°C	95% coverage min., good and no visible damage	d tinning	
Temperature cycling	30 minutes at -55°C ±3°C, 2~3 minutes at 20°C +5°C -1°C, 30 minutes at +125°C ±3°C, 2~3 minutes at 20°C +5°C -1°C, total 5 continuous cycles		<50mΩ	
Damp heat (Load life in humidity)	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C ±2°C and 90~95% relative humidity	ΔR/R max. ±(5%+0.1Ω)	<50mΩ	
Load life (Endurance)	1000 +48/-0 hours; loaded with RCWV or Vmax in chamber controller 70 ±2°C, 1.5 hours on and 0.5 hours off	ΔR/R max. ±(5%+0.1Ω)	<50mΩ	
High temperature	125°C × 1000 hrs, no load	$\Delta$ R/R max. ±(5%+0.1 $\Omega$ )	<50mΩ	
Bending strength	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec.	No visual damaged, $\Delta$ R/R max. $\pm (1\%+0.05\Omega)$		
Adhesion	Pressurizing force: 3N, Test time: 10±1sec.	No remarkable damage removal of the termination		

# Packaging:

## **Paper Tape specifications**



Series No.	Α	В	W	F	E
MCWR02X	0.67 ±0.05	0.37 ±0.05	8 ±0.2	3.5 ±0.05	1.75 ±0.1
Series No.	P1	P0	ØD	Т	
MCWR02X	2 ±0.05	4 ±0.05	+0.1 1.5 -0.0	0.45 ±0.05	

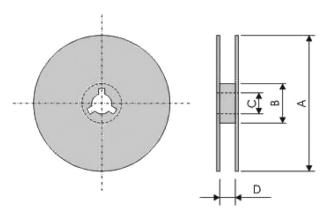
Dimensions : Millimetres

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#### **Reel Dimensions:**



Symbol	Α	В	С	D
7" Reel	178 ±0.2	60 ±1	13 ±0.2	9 ±0.5
10" Reel	254 ±2	100 ±1	13 ±0.2	9 ±0.5
13" Reel	330 ±2	100 ±1	13 ±0.2	9 ±0.5

Dimensions: Millimetres

# **Part Number Explanation**

MCWR02	Х	472_	J	Α	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
MCWR02 : 0201	X : Normal W : 1% For <10Ω and >1MΩ	5%, E24: 2 significant digits followed by no. of zeros and a blank. $4.7\Omega = 4R7\_$ $100\Omega = 101\_$ $10k\Omega = 103\_$ 1%, E24+E96: 3 significant digits followed by no. of zeros $100\Omega = 1000$ $37.4k\Omega = 3742$	J:±5% F:±1% P:Jumper	A: 7" Reeled taping (15Kpcs/Reel) T: 7" Reeled taping (10Kpcs/Reel) D: 7" Reeled taping (20Kpcs/Reel) H: 13" Reeled taping (50Kpcs/Reel) G: 13" Reeled taping (70Kpcs/Reel)	L = Sn base (lead free)

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